## ปฐิเLITY PAŢENT APPLICATION TRANSMITTAL (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. 6161.0124.US

Total Pages in this Submiss

### TO THE COMMISSIONER FOR PATENTS

**Mail Stop Patent Application** P.O. Box 1450 Alexandria, VA 22313-1450

Transmitted herewith for filing under 35 U.S.C. 111(a) and 37 C.F.R. 1.53(b) is a new utility patent application for an

### FLAT PANEL DISPLAY WITH THIN FILM TRANSISTOR    Jae-Bon KOO;   Ji-Yong PARK;   Hive-Hiyang PARK;   Hive-Hiyang PARK;   Ki-Yong LEE and UI-Ho LEE	invent	nvention entitled:								
and invented by:    Jae-Bon KOO;   Ji-Yong PARK;   Hye-Hyang PARK;	FI	FLAT PANEL DISPLAY WITH THIN FILM TRANSISTOR								
and invented by:  Jae-Bon KOO; Ji-Yong PARK; Hye-Hyang PARK; Ki-Yong LêE and U-Ho LêE  If a CONTINUATION APPLICATION, check appropriate box and supply the requisite information:  Continuation Divisional Continuation-in-part (CIP) of prior application No.:  Which is a:  Continuation Divisional Continuation-in-part (CIP) of prior application No.:  Application Elements  1. ☑ Filing fee as calculated and transmitted as described below  2. ☑ Specification having 46 pages and including the following:  a. ☑ Descriptive Title of the Invention  b. ☑ Cross References to Related Applications (if applicable)  c. ☐ Statement Regarding Federally-sponsored Research/Development (if applicable)  d. ☐ Reference to Sequence Listing, a Table, or a Computer Program Listing Appendix  e. ☑ Background of the Invention  f. ☑ Brief Summary of the Invention  g. ☑ Brief Description of the Drawings (if filed)  h. ☑ Detailed Description  i. ☑ Claim(s) as Classified Below										
Jac-Bon KOO; Ji-Yong PARK; Ki-Yong LEE and Ui-Ho LEE  If a CONTINUATION APPLICATION, check appropriate box and supply the requisite information: Continuation Divisional Continuation-in-part (CIP) of prior application No.: Which is a: Continuation Divisional Continuation-in-part (CIP) of prior application No.: Which is a: Continuation Divisional Continuation-in-part (CIP) of prior application No.:  Enclosed are:  Application Elements  1. Seliting fee as calculated and transmitted as described below 2. Sepecification having 46 pages and including the following: a. Descriptive Title of the Invention b. Cross References to Related Applications (if applicable) c. Statement Regarding Federally-sponsored Research/Development (if applicable) d. Reference to Sequence Listing, a Table, or a Computer Program Listing Appendix e. Background of the Invention f. Brief Summary of the Invention g. Brief Description of the Drawings (if filed) h. Detailed Description i. Claim(s) as Classified Below	 and in	vente	ed by							
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(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. 6161.0124.US

Total Pages in this Submission

Applicati n Elements (C ntinued)										
3.	$\boxtimes$	Drawing(s) (when necessary as prescribed by 35 USC 113)								
	a.	□ Number of Sheets								
	b.	☐ Informal Number of Sheets								
4.	X	Oath or Declaration								
	a.	Newly executed (original or copy) □ Unexecuted								
	b.	☐ Copy from a prior application (37 CFR 1.63(d)) (for continuation/divisional application only)								
	C.	☐ With Power of Attorney ☑ Without Power of Attorney								
	d.	DELETION OF INVENTOR(S) Signed statement attached deleting inventor(s) named in the prior application, see 37 C.F.R. 1.63(d)(2) and 1.33(b).								
5.		Incorporation By Reference (usable if Box 4b is checked) The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.								
6.		CD ROM or CD-R in duplicate, large table or Computer Program (Appendix)								
7.		Application Data Sheet (See 37 CFR 1.76)								
8.		Nucleotide and/or Amino Acid Sequence Submission (if applicable, all must be included)								
	a.	☐ Computer Readable Form (CRF)								
	b.	☐ Specification Sequence Listing on:								
		i. CD-ROM or CD-R (2 copies); or								
		ii. 🗖 Paper								
	C.	Statement(s) Verifying Identical Paper and Computer Readable Copy								
		Accompanying Application Parts								
9.	$\boxtimes$	Assignment Papers (cover sheet & document(s))								
10.	$\boxtimes$	37 CFR 3.73(B) Statement (when there is an assignee)								
11.		English Translation Document (if applicable)								
12.	$\boxtimes$	Information Disclosure Statement/PTO-1449   Copies of IDS Citations								
13.		Preliminary Amendment								
14.	$\boxtimes$	Return Receipt Postcard (MPEP 503) (Should be specifically itemized)								
15.	$\boxtimes$	Certified Copy of Priority Document(s) (if foreign priority is claimed)								
16.		Certificate of Mailing								
		☐ First Class ☐ Express Mail (Specify Label No.):								

# UTILITY PATENT APPLICATION TRANSMITTAL (Larg Entity)

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(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No. 6161.0124.US

Total Pages in this Submission

	Accompanying Application Parts (Continued)
17.	Additional Enclosures (please identify below):
	Request That Application Not Be Published Pursuant To 35 U.S.C. 122(b)(2)
18.	Pursuant to 35 U.S.C. 122(b)(2), Applicant hereby requests that this patent application not be published pursuant to 35 U.S.C. 122(b)(1). Applicant hereby certifies that the invention disclosed in this application has not and will not be the subject of an application filed in another country, or under a multilateral international agreement, that requires publication of applications 18 months after filing of the application.
	Warning
	An applicant who makes a request not to publish, but who subsequently files in a foreign country or under a multilateral international agreement specified in 35 U.S.C. 122(b)(2)(B)(i), must notify the Director of such filing not later than 45 days after the date of the filing of such foreign or international application. A failure of the applicant to provide such notice within the prescribed period shall result in the application being regarded as abandoned, unless it is shown to the satisfaction of the Director that the delay in submitting the notice was unintentional.

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CC:

# UTILITY PATENT APPLICATION TRANSMITTAL (Large Entity)

Docket No. 6161.0124.US

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Total Pages in this Submission

#### **Fee Calculation and Transmittal**

		CLAIMS	S AS FILED				
For	#Filed	#Allowed	#Extra	Rate		Fee	
Total Claims	37	- 20 =	17	× \$18.0	0	\$306.00	
ndep. Claims	1	- 3 =	0	x \$86.0	0	\$0.00	
Multiple Dependen	t Claims (check	if applicable)				\$0.00	
BASIC FEE							
OTHER FEE (spec	cify purpose)					\$0.00	
				тот	AL FILING FEE	\$1,076.00	
A check in the amount of \$1,076.00 to cover the filing fee is enclosed.  The Director is hereby authorized to charge and credit Deposit Account No. 23-1951 as described below.  Charge the amount of as filing fee.  Credit any overpayment.  Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17.  Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance, pursuant to 37 C.F.R. 1.311(b).							
Dated: January 12, 2003				Hae Chan Park,Reg. N . 50,114 McGuireW ds LLP			

1750 Tysons Blvd., Suite 1800 McLean, Virginia 22102

Telephone: 703-712-5365 Facsimile: 703-712-5280

hpark@mcguirewoods.com Direct Fax: 703.712.5280

January 12, 2004

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

RE:

Application No. Unassigned Filed: January 12, 2004

FLAT PANEL DISPLAY WITH THIN FILM TRANSISTOR

Inventor: Jae-Bon KOO, et al. Our Ref:: 6161.0124.US

Sir:

The following documents are forwarded herewith for appropriate action by the U.S. Patent and Trademark Office:

- 1. This Transmittal Letter;
- 2. A Utility Patent Application Transmittal Form;
- 3. A Specification containing 46 pages and 12 sheets of drawings (Figs. 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15A, 15B, 15C, 15D, 15E, 15F, 15G, 15H, 15I, 16A, 16B and 16C);
- 4. An executed Declaration;
- A Form PTO-1595 Recordation Cover Sheet and a copy of the executed Assignment to Samsung SDI Co., Ltd., a recordation of which is hereby respectfully requested;
- 6. An executed Statement under 37 C.F.R. § 3.73(b), Power of Attorney by Assignee;
- 7. Claim for Priority to and a Certified Copy of:
  Korean Patent Application Nos. 2003-0026004; 2003-0026007; 2003-0027992
  and 2003-0038826;
- 8. An Information Disclosure Statement and Form 1449 with copies of Japanese Patent Publication Nos: hei 5-107561, 2001-109399, 2001-290441;
- 9. Our Check No. 150471 in the amount of \$1076.00 to cover the filing fee and Check No. 150468 in the amount of \$40.00 to cover the Assignment Recordation Fee; and
- 10. Two acknowledgement postcards.

U.S. Patent & Trademark Office ปลานary 12, 2004 Page 2

It is respectfully requested that the attached copy of the postcard be stamped with the filing date of these documents and returned to our courier.

The U.S. Patent and Trademark Office is hereby authorized to charge any fee deficiency, or credit any overpayment, to our Deposit Account No. 23-1951 referencing docket number 6161.0124.US.

Respectfully submitted,

Hae-Chan Park

Reg. No. 50,114

HCP/jmp Enclosures

\\COM\382824.1

#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	)
Jae Bon PARK, et al.	)
Application No.: TBD	) Group Art Unit: TBD
Filed: TBD	) Examiner: TBD
For: FLAT PANEL DISPLAY WITH	THIN FILM TRANSISTOR

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

#### STATEMENT UNDER 37 C.F.R. § 3.73(b), POWER OF ATTORNEY BY ASSIGNEE

Samsung SDI Co., Ltd., a Korean corporation, states that it is the assignee of the entire right, title, and interest in the above-mentioned patent applications by virtue of assignments from their respective inventor(s). A copy of the Assignment document is attached.

The assignee of the above-identified patent application hereby appoints the registered practitioners of McGuireWoods LLP included in the following customer number to prosecute the above application and transact all business in the U.S. Patent and Trademark Office connected therewith, and directs that all correspondence be addressed to that Customer Number:

**CUSTOMER NUMBER: 23345** 

Address correspondence to:

McGuireWoods LLP 1750 Tysons Boulevard Suite 1800 McLean, VA 22102

Docket No.: 6161.0124.US

Direct Telephone Calls to Hae-Chan Park, Esq. at 703-712-5365.

On behalf of Samsung SDI Co. Ltd.:

FOR: Samsung SDI Co. Ltd.

SIGNATURE:

BY: Byung-Su HAN

TITLE: Senior Manager

DATE:

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